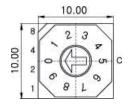
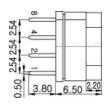
Rotary Switches

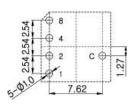
10 x 10 mm Sealed Rotary DIP Switches

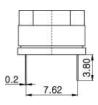
RD83 Series







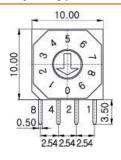


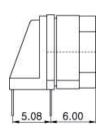


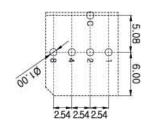
RD83(T)H

THT Top Adjust Type Terminals





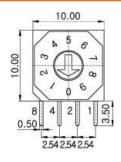


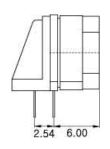


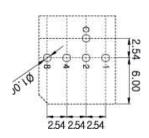
RD83(T)A1

THT Angel Type Terminals





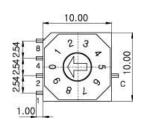




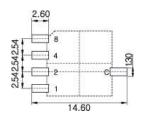
RD83(T)A2

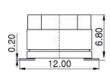
THT Angel Type Terminals











RD83(T)S SMT Top Type Terminals

How to order:



SOLDERING CONDITIONS:

blank PCB Hole Type

Through Hole Reflow (THR) т

TYPE OF TERMINALS:

- THT Top Adjust Type н
- A1 THT Angel Type (5.08)
- A2 THT Angel Type (2.54)
- S SMT Top Type

3 **ROTOR TYPE (See Above Drawings):**

- Arrow Type
- **S2 Shaft Type**
- **S3** Cross Type
- Raised Type

NO. OF POSITIONS:

- 04 04 Positions
- 06 06 Positions
- 08 Positions
- 10 10 Positions
- 16 16 Positions

CODE:

- Real Code
- Complementary Code

PACKAGING TYPE:

- Tape & Reel (RD83S Only)

General Specifications:

FEATURES

» Sealing: IP 67(Dust & Waterproof)

MECHANICAL

- » Life Cycle: 10.000 steps
- » Operating Force: 700 gf max.

- » Contact Rating: 150mA, 24V (Switching)
 - 400mA, 24V (None-Switching)
- » Contact Resistance: 80mΩ Max
- » Insulation Resistance: $100M\Omega$ Min

SOLDERING CONDITIONS

- » THT Type: Solder iron max: 2s./340°C
 - Solder bath max: 5s/280°C
- » THR Type: Reflow Soldering: 10s/260°C
 - Solder iron max: 2s/340°C
 - Wave Soldering: 5s/280°C
- » SMT Type: Solder reflow max: 10s./260°C Solder iron max: 2s./340°C
 - Solder bath max: 5s/280°C

PACKING

- » Tube: 50pcs / Tube
- » Reel: 600pcs / Reel

RD83 Series

ROTOR TYPE

S1





S2







S3









S4



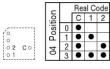




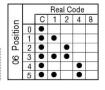


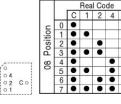
CODE

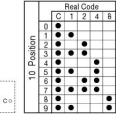
Real Code





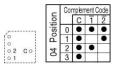




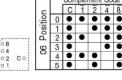


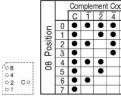
			nea	100	ue		
		С	1	2	4	8	
	0	•					0
	1	•	•				
	2	•		•			2
	3	•	•	•			3
_	4	•			•		1 2 3 4 5
16 Position	5	•	•		•		5
Si	6	•		•	•		6
Д	7	•	•	•	•		7
9	8	•				•	
-	9	•	•			•	9
	10	•		•		•	Α
j	11	•	•	•		•	В
	12	•			•	•	C
	13	•	•		•	•	8 9 A B C D E
	14	•		•	•	•	Ε
	15	•	•	•	•	•	F

Complement Code







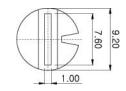


1		Complement Co							
			С	1	2	4	8		
		0	•	•	•	•	•		
	-	1	•		•	•	•		
	osition	2	•	•		•	•		
	S.	3	•			•	•		
	P	4	•	•	•		•		
	0	5	•		•		•		
·	-	6	•	•	- 1		•		
08		7	•				•		
02 CO		8	•	•	•	•			
0.1	- 1	9	•		•	•			

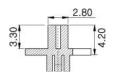
ì	- 1	001	ipic	men	100		ii.
	ı	C	1	2	4	8	
		•	•	•	•	•	0
1	ı	•		•	•	•	1
1	- 1	•	•		•	•	2
	- [•			•	•	3
1	_	•	•	•		•	4
1	16 Position	•		•		•	5
	Si	•	•			•	6
	ĭ	•				•	7
	9	•	•	•	•		8
1	-	•		•	•		9
1	- [•	•		•		Α
		•			ě		В
		•	•	•			C
	[•		•	_		1 2 3 4 5 6 7 8 9 A B C D E F
	[•	•				E
	_[•					F

ACCESSORIES









(applicable to only "S3" actuators Should be mounted after soldering)

H: Grey C: Red A: Black E: Yellow G: Blue

SPECIFICATIONS

1. Style:

This specification describes "Rotary Switch" mainly used as signal switch of electric devices with the general requirements of mechanical and electrical characteristics.

- 1.1 Operating Temperature for PCB Hold Type: -20°C to +70°C Storage Temperature Range: -40°C to +85°C
- 1.2 Operating / Storage Temperature Range for THR Type: -60°C to +125°C
- 2. Current Range:

2.1 None-Switching : 400mA, 24V2.2 Switching : 150mA, 24V

3. Type of Actuation: Rotating

4. Test Sequence

	ITEM	DESCRIPTION	TEST CONDITIONS	REQUIREMENTS
E L E	1	Visual Examination	By visual examination check without any out pressure & testing.	There shall be no defects that affect the serviceability of the product
C T R I C	2	Contact Resistance	 To be measured between the two terminals associated with each switch pole Measurements shall be made with a 1kHz shall current contact resistance meter 	80 mΩ max
F O R M	3	Insulation Resistance	250V DC, 1minute ±5seconds	100MΩ min
A N C E	4	Dielectric withstanding Voltage	250V AC(50Hz or 60Hz)shall be applied between all the adjacent terminal and between the terminal and the frame For 1 minute	There shall be no breakdown or flash over
	5	Operation Force	Applied in the direction of operation	700gf/cm. max

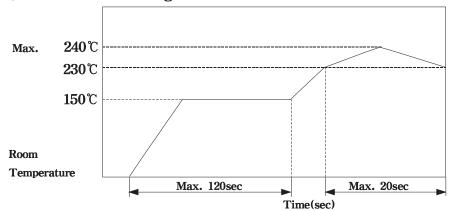
	6	Stop Strength	A static load of 1 kgf is vertical direction operate of 15 seconds.	There shall be no sign of damage mechanically.
M E C H A N I C	7	Soldering Heat Resistance	As shown in item 2~6	
P E R F O R M A N C E	8	Vibration	Shall be vibrated in accomethod 201A of MIL-S' 1)Frequency: 10-55-10 2)Direction: 3 vertical dothe direction of operate 3)Test time: 2 hours each	As shown in item 2~6
	9	Shock	Shall be shocked in accomethod 213B condition 1)Acceleration: 50G 2)Action time: 11 ±1 m 3)Testing direction: 6 si 4)Test cycle: 3 times in	As shown in item 2~6
	10	Solderabi-lity	1)Soldering temperature: 2)Flux: 5-10 seconds. 3)Duration of solder lim	No anti-soldering and coverage of dipping into solder must more than 75% was requested

	11	Operation Life	Measurements shall be made following the test set forth below: 1)25mA, 24V DC resistive load 2)Rate of operation: 15~20 cycles/ minute 3)Step of operation: 10,000 steps	1)As shown in item 3,4 2)Contact Resistance: 200mΩ max 3)Final-after test
W E A T H E R P R O O F	12	Resistance Low Temperature Temperature Temperature Temperature Temperature Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1) Temperature: -60° $\pm 3^{\circ}$ 2) Time: 96 hours		As shown in item 2~6
	13	Resistance High Temperature	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1) Temperature: $125^{\circ}\!$	1)As shown in item 3~6 2)Contact Resistance: 200mΩ max
	14	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1) Temperature: $40\% \pm 2\%$ 2) Relative humidity: $90 \sim 95\%$ 3) Time: 96 hours		1)As shown in item 4,6 2)Contact Resistance: 200mΩ max 3)Insulation Resistance: 10MΩ min

5. Soldering Conditions:

PCB Hole Type

1)Condition for Soldering



2) It should be used not to allow switch's surface temperature to exceed 240°C.

3)Manual Soldering

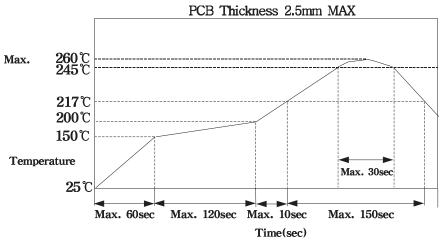
Soldering Temperature	Max. 350℃
Continuous Soldering	Max. 3sec

4)Precautions in Handling

Care should be exercised so that flux from the upper part of the printed circuit board does not adhere to the switch.

THR Type

1)Condition for Soldering



2) The condition mentioned above is the temperature on the Cu foil of PCB surface.

There are where board's temperature greatly differs from switch's surface temperature depending on board's material, size, thickness, etc. Care, therefore, should be used not to allow switch's surface temperature to exceed $260\,^{\circ}$ C.

3)Precautions in Handling

Care should be exercised so that flux from the upper part of the printed circuit board does not adhere to the switch.

Rotary Switches

10 x 10 mm Sealed Rotary DIP Switches

RD83 Series

6. This item is "ROHS" Compliant

7. Part List

NO	PART NAME	Q'TY	MATERIALS	TREATMENT	REMARK
1	COVER	1	PA66 (PCB Hole Type)		Print:Black
2	BASE	1	LCP (THR Type)		
3	ACTUATOR	1	PA66, STS		
4	CONTACT & TERMINAL	1	PHOSPHOR BRONZE	CONTACT AND TERMINAL PLATING: GOLD PLATING OVER NICKEL	Au 0.07 1μm Min Ni 0.1μm Min
5	PCB	1	EPOXY	PLATING: GOLD PLATING	Au 0.05μm Min
6	O-Ring	1	SILICONE		

